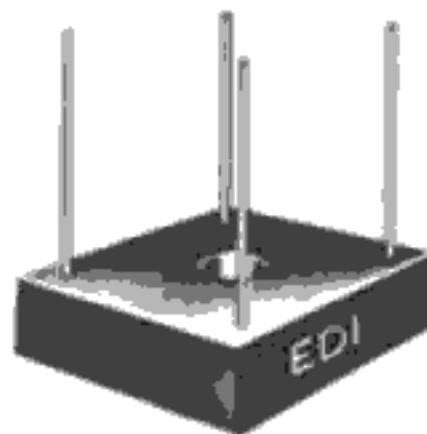




SINGLE-PHASE FULL WAVE BRIDGE
2.0 AMPERES FOR P.C. BOARD MOUNTING
3.0 AMPERES HEAT SINK MOUNTING



PV SERIES

| | | | | | | | |
|----------|------|------|------|------|------|------|-------|
| PRV/leg | 50V | 100V | 200V | 400V | 600V | 800V | 1000V |
| Type No. | PV05 | PV10 | PV20 | PV40 | PV60 | PV80 | PV100 |

ELECTRICAL CHARACTERISTICS PER LEG
(at $T_A=25^\circ\text{C}$ Unless Otherwise Specified)

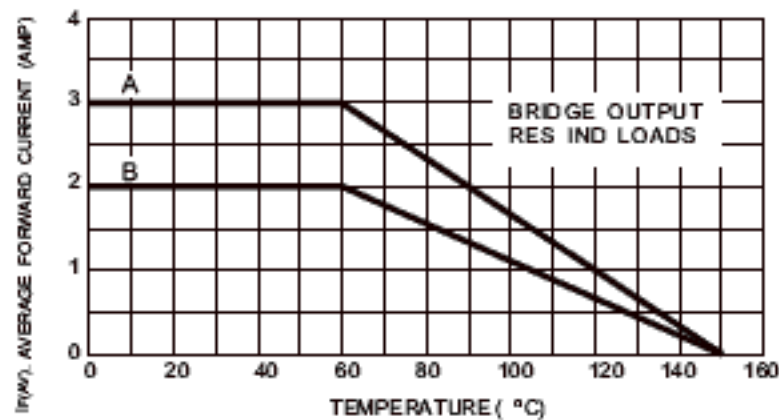
| | | |
|--|-------------|------------------|
| Max. Forward Voltage Drop, $V_F=1.0\text{V}$ @ $I_F=$ | 1.0 | Amp |
| Max. DC Reverse Current @ PRV and 25°C , I_R | 10.0 | μA |
| Max. Peak Surge Current, I_{FSM} (8.3ms) | 50 | Amp |
| Ambient Operating Temperature Range, T_A | -55 to +150 | $^\circ\text{C}$ |
| Storage Temperature Range, T_{STG} | -55 to +150 | $^\circ\text{C}$ |

NOTE:

Maximum lead and terminal temperature for soldering, 3/8 inch from case, 5 seconds at 250°C

EDI reserves the right to change these specifications at any time without notice.

Figure 1
PV SERIES CURRENT DERATING



A = CASE TEMPERATURE, HEAT SINK MOUNTED
B = AMBIENT TEMPERATURE

Figure 2
NON-REPETITIVE SURGE CURRENT

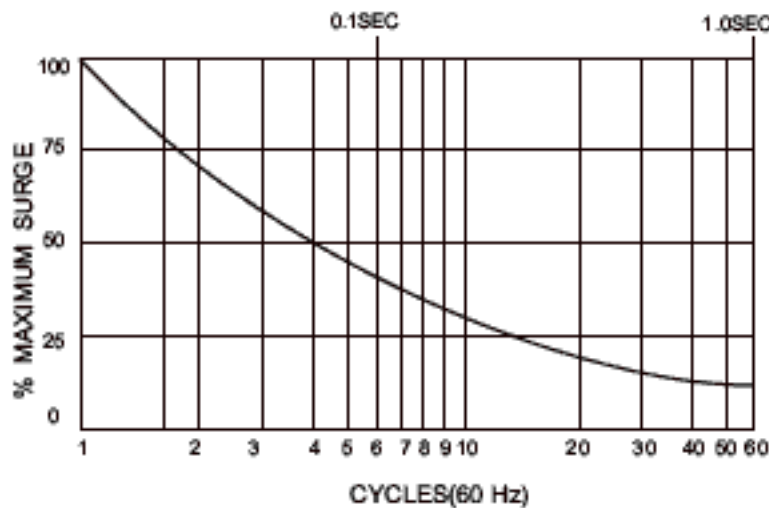
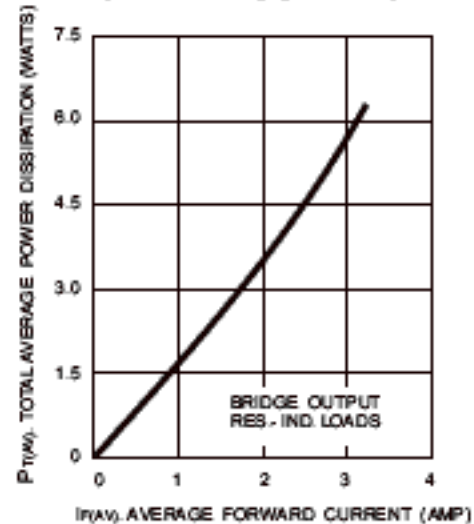
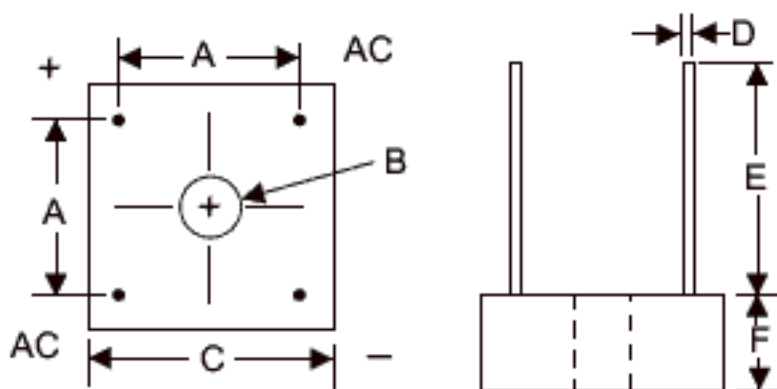


Figure 3
POWER DISSIPATION



PV SERIES MECH. OUTLINE



| LTR | INCHES | MILLIMETERS |
|-----|--------------|--------------|
| A | .411-.441 | 10.44-11.20 |
| B | .137-.167DIA | 3.48-4.24DIA |
| C | .590-.610 | 14.99-15.49 |
| D | .038-.042 | .97-1.07 |
| E | .750MIN | 19.05MIN |
| F | .300MAX | 7.62MAX |

NOTE: 1. A thin film of silicone thermal compound is recommended between the bridge case and mounting surface for improved thermal conduction.